

SUPPLY-CHAIN PERFORMANCE WORKING GROUP MINUTES

Date: May 27, 2009
Location: Teleconference
Time: 11:00am – 12:00pm (Pacific)
Participants:

Roger DeAmicis – ChipX
Jay Seaton – Evolutionary Operations Consulting LLC
Dan Wark – Amalfi Semiconductor Inc.
George Wu – PMC-Sierra, Inc.
Chelsea Boone – GSA

Meeting Purpose:

- To discuss the Q2 2009 Wafer & Back-End Pricing Survey Results.

Actions Completed/Items Discussed:

- Q2 2009 WP & BE Survey Results
- Future Timelines/Dates for Next Survey

End Result/Conclusions:

- **Q2 2009 WP & BE Survey Results:**
 - Assembly
 - Delete lines 5,7,9 in spreadsheet
 - Need to challenge the yield selection in lines 10 and 11 in spreadsheet. It should only be assembly yield.
 - Wafer
 - Delete line 4
 - Line 5 – Is it really production, or more engineering? We will leave the record in.
 - Mask
 - Delete lines 2,7,10,11 in spreadsheet.
- **Future Timelines/Dates for Next Survey:**
 - Q2 2009 Wafer & Back-End Pricing Report Released: 6/15/2009
 - Q3 2009 Wafer & Back-End Pricing Survey Released: 7/1/2009
 - Q3 2009 Wafer & Back-End Pricing Survey Ends: 7/22/2009
 - Q3 2009 Working Group Meeting to discuss Q3 09 results: Week of 8/10/2009